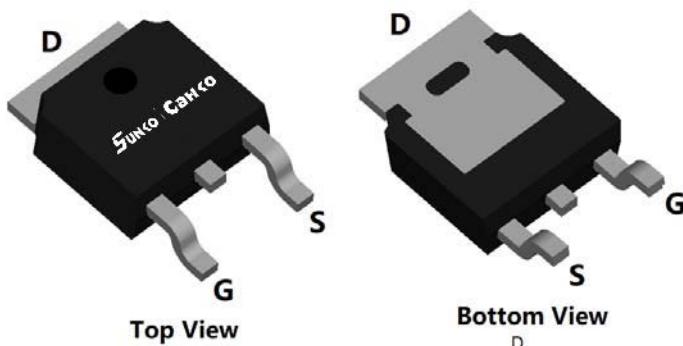
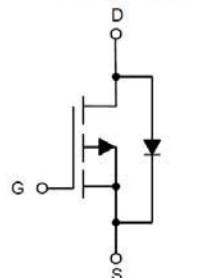


## P-Channel Enhancement Mode Field Effect Transistor



**TO-252**



### Product Summary

- $V_{DS}$  -100V
- $I_D$  -18A
- $R_{DS(on)}$  (at  $V_{GS}=-10V$ ) <110 mΩ
- $R_{DS(on)}$  (at  $V_{GS}=-4.5V$ ) <120 mΩ
- 100% EAS Tested
- 100%  $\nabla V_{DS}$  Tested

### General Description

- Split gate trench MOSFET technology
- Low  $R_{DS(on)}$  & FOM
- Extremely low switching loss
- Excellent stability and uniformity
- Moisture Sensitivity Level 1
- Epoxy Meets UL 94 V-0 Flammability Rating
- Halogen Free

### Applications

- Power management
- Portable equipment

### ■ Absolute Maximum Ratings ( $T_A=25^\circ C$ unless otherwise noted)

| Parameter                              |                   | Symbol         | Limit    | Unit |
|--|-------------------|----------------|----------|------|
| Drain-source Voltage                   |                   | $V_{DS}$       | -100     | V    |
| Gate-source Voltage                    |                   | $V_{GS}$       | $\pm 20$ | V    |
| Drain Current                          | $T_c=25^\circ C$  | $I_D$          | -18      | A    |
|  | $T_c=100^\circ C$ |                | -12      |      |
| Pulsed Drain Current <sup>A</sup>      |                   | $I_{DM}$       | -72      | A    |
| Avalanche energy <sup>B</sup>          |                   | EAS            | 72       | mJ   |
| Total Power Dissipation <sup>C</sup>   | $T_c=25^\circ C$  | $P_D$          | 72       | W    |
|  | $T_c=100^\circ C$ |                | 29       |      |
| Junction and Storage Temperature Range |                   | $T_J, T_{STG}$ | -55~+150 | °C   |

### ■ Thermal resistance

| Parameter   |              | Symbol          | Typ  | Max | Units |
|---|--------------|-----------------|------|-----|-------|
| Thermal Resistance Junction-to-Ambient <sup>D</sup> | Steady-State | $R_{\theta JA}$ | 40   | 50  | °C/W  |
| Thermal Resistance Junction-to-Case                 | Steady-State | $R_{\theta JC}$ | 1.35 | 1.7 |       |

### ■ Ordering Information (Example)

| PREFERRED P/N | PACKING CODE | Marking  | MINIMUM PACKAGE(pcs) | INNER BOX QUANTITY(pcs) | OUTER CARTON QUANTITY(pcs) | DELIVERY MODE |
|---------------|--------------|----------|----------------------|-------------------------|----------------------------|---------------|
| SCD18GP10A    | F1/F2 SC     | D18GP10A | 2500                 | /                       | 25000                      | 13" reel      |

■ Electrical Characteristics ( $T_J=25^\circ\text{C}$  unless otherwise noted)

| Parameter                             | Symbol                     | Conditions   | Min  | Typ  | Max       | Units            |
|---------------------------------------|----------------------------|--|------|------|-----------|------------------|
| <b>Static Parameter</b>               |                            |  |      |      |           |                  |
| Drain-Source Breakdown Voltage        | $\text{BV}_{\text{DSS}}$   | $V_{\text{GS}}=0\text{V}, I_{\text{D}}=-250\mu\text{A}$  | -100 | -    | -         | V                |
| Zero Gate Voltage Drain Current       | $I_{\text{DSS}}$           | $V_{\text{DS}}=-100\text{V}, V_{\text{GS}}=0\text{V}$  | -    | -    | -1        | $\mu\text{A}$    |
|                                       |                            | $V_{\text{DS}}=-100\text{V}, V_{\text{GS}}=0\text{V}, T_J=150^\circ\text{C}$                           | -    | -    | -100      |                  |
| Gate-Body Leakage Current             | $I_{\text{GSS}}$           | $V_{\text{GS}}=\pm 20\text{V}, V_{\text{DS}}=0\text{V}$  | -    | -    | $\pm 100$ | nA               |
| Gate Threshold Voltage                | $V_{\text{GS}(\text{th})}$ | $V_{\text{DS}}=V_{\text{GS}}, I_{\text{D}}=-250\mu\text{A}$  | -1.0 | -1.8 | -2.5      | V                |
| Static Drain-Source On-Resistance     | $R_{\text{DS}(\text{on})}$ | $V_{\text{GS}}=-10\text{V}, I_{\text{D}}=-10\text{A}$  | -    | 83   | 110       | $\text{m}\Omega$ |
|                                       |                            | $V_{\text{GS}}=-4.5\text{V}, I_{\text{D}}=-5\text{A}$  | -    | 95   | 120       |                  |
| Diode Forward Voltage                 | $V_{\text{SD}}$            | $I_{\text{S}}=-10\text{A}, V_{\text{GS}}=0\text{V}$  | -    | -    | -1.3      | V                |
| Gate resistance                       | $R_{\text{G}}$             | $f=1\text{MHz}, \text{Open drain}$   | -    | 10   | -         | $\Omega$         |
| Maximum Body-Diode Continuous Current | $I_{\text{S}}$             |  | -    | -    | -18       | A                |
| <b>Dynamic Parameters</b>             |                            |  |      |      |           |                  |
| Input Capacitance                     | $C_{\text{iss}}$           | $V_{\text{DS}}=-50\text{V}, V_{\text{GS}}=0\text{V}, f=1\text{MHz}$                                    | -    | 1051 | -         | $\text{pF}$      |
| Output Capacitance                    | $C_{\text{oss}}$           |  | -    | 119  | -         |                  |
| Reverse Transfer Capacitance          | $C_{\text{rss}}$           |  | -    | 25   | -         |                  |
| <b>Switching Parameters</b>           |                            |  |      |      |           |                  |
| Total Gate Charge                     | $Q_{\text{g}}$             | $V_{\text{GS}}=-10\text{V}, V_{\text{DS}}=-50\text{V}, I_{\text{D}}=-5\text{A}$                        | -    | 20.1 | -         | $\text{nC}$      |
| Gate-Source Charge                    | $Q_{\text{gs}}$            |  | -    | 3.9  | -         |                  |
| Gate-Drain Charge                     | $Q_{\text{gd}}$            |  | -    | 4.3  | -         |                  |
| Reverse Recovery Charge               | $Q_{\text{rr}}$            | $I_{\text{F}}=-5\text{A}, \text{di/dt}=100\text{A/us}$   | -    | 140  | -         | $\text{nC}$      |
| Reverse Recovery Time                 | $t_{\text{rr}}$            |  | -    | 70   | -         | ns               |
| Turn-on Delay Time                    | $t_{\text{D(on)}}$         | $V_{\text{GS}}=-10\text{V}, V_{\text{DD}}=-50\text{V}, R_{\text{L}}=2.5\Omega, R_{\text{GEN}}=6\Omega$ | -    | 10   | -         | ns               |
| Turn-on Rise Time                     | $t_{\text{r}}$             |  | -    | 30   | -         |                  |
| Turn-off Delay Time                   | $t_{\text{D(off)}}$        |  | -    | 77   | -         |                  |
| Turn-off fall Time                    | $t_{\text{f}}$             |  | -    | 81   | -         |                  |

- A. Repetitive rating; pulse width limited by max. junction temperature.  
 B.  $T_J=25^\circ\text{C}, V_{\text{DD}}=-50\text{V}, V_{\text{G}}=-10\text{V}, R_{\text{G}}=25\Omega, L=0.5\text{mH}, I_{\text{AS}}=-17\text{A}$ .  
 C.  $P_d$  is based on max. junction temperature, using junction-case thermal resistance.  
 D. The value of  $R_{\theta JA}$  is measured with the device mounted on 1in2 FR-4 board with 2oz. Copper, in a still air environment with  $T_A = 25^\circ\text{C}$ . The maximum allowed junction temperature of  $150^\circ\text{C}$ . The value in any given application depends on the user's specific board design.

## ■ Typical Electrical and Thermal Characteristics Diagrams

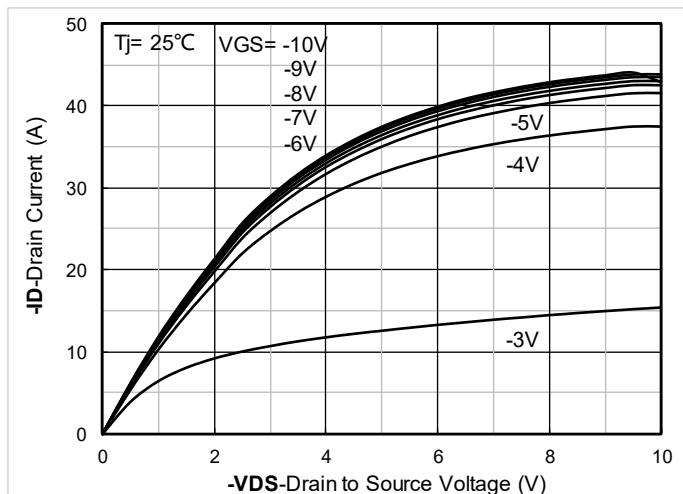


Figure 1. Output Characteristics

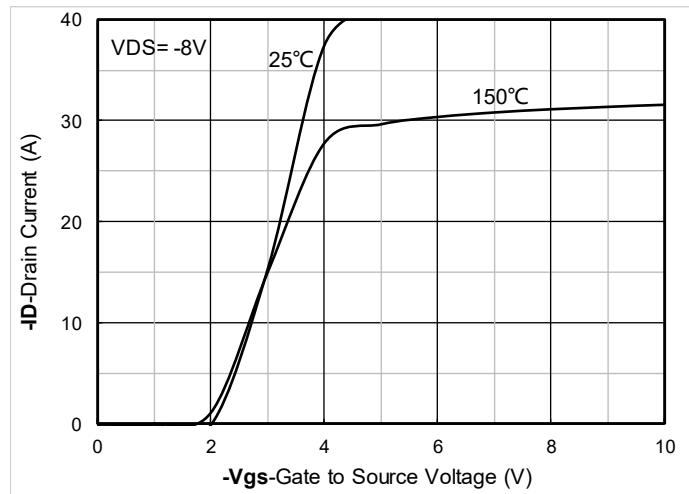


Figure 2. Transfer Characteristics

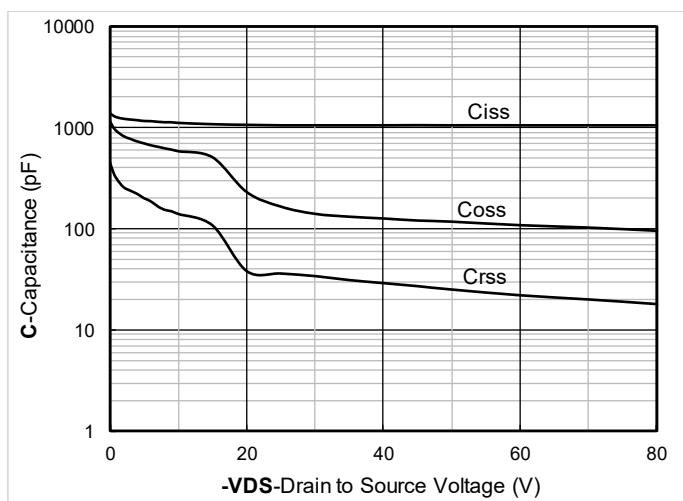


Figure 3. Capacitance Characteristics

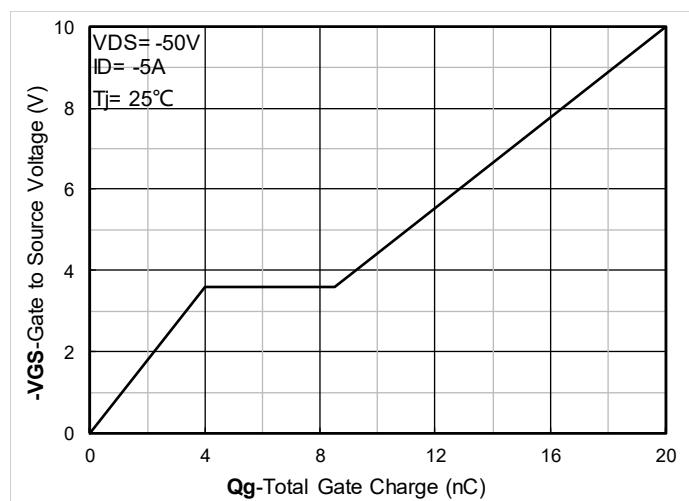


Figure 4. Gate Charge

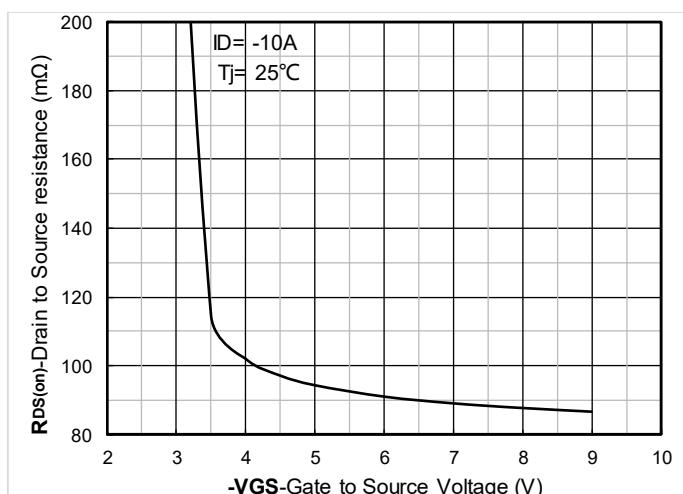


Figure 5. On-Resistance vs Gate to Source Voltage

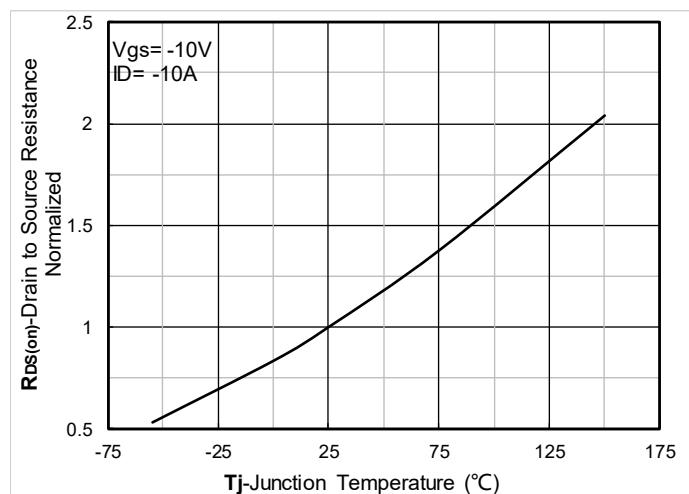


Figure 6. Normalized On-Resistance

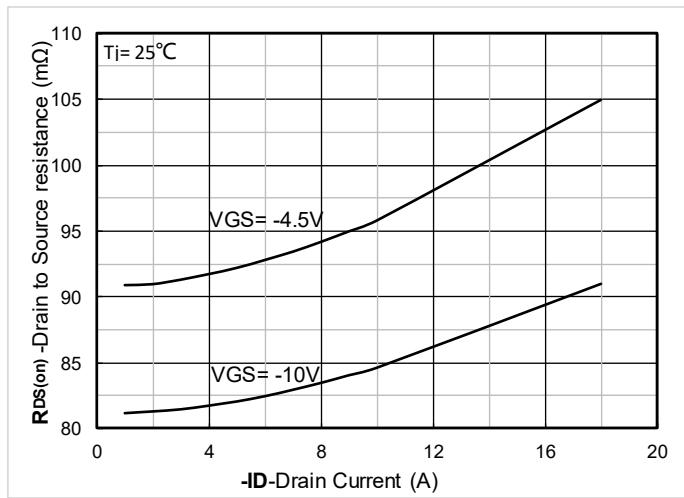


Figure7. RDS(on) VS Drain Current

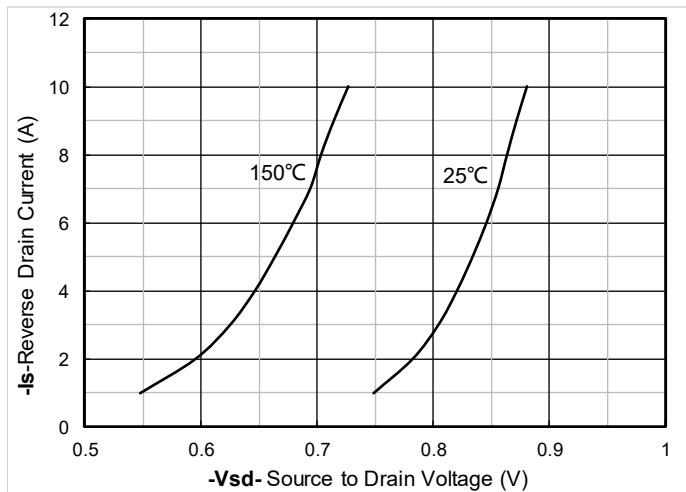


Figure8. Forward characteristics of reverse diode

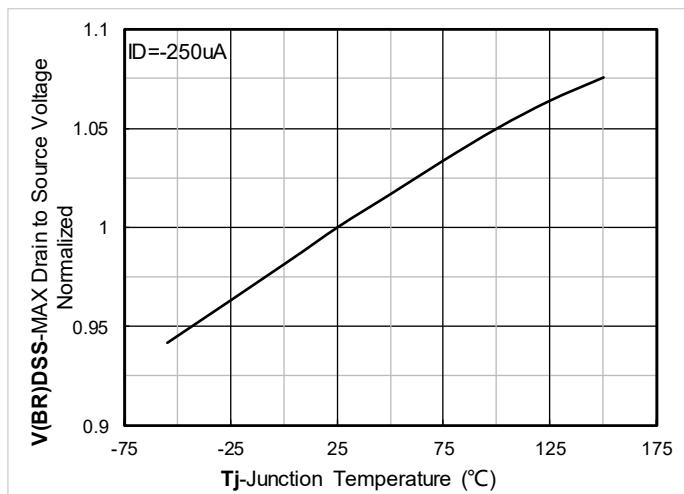


Figure9. Normalized breakdown voltage

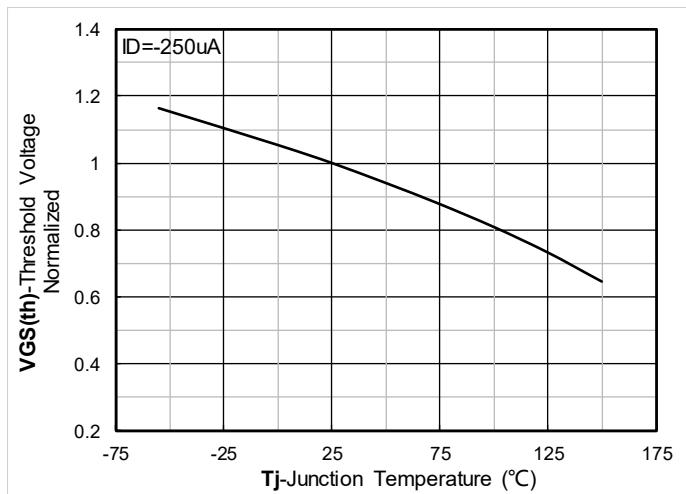


Figure10. Normalized Threshold voltage

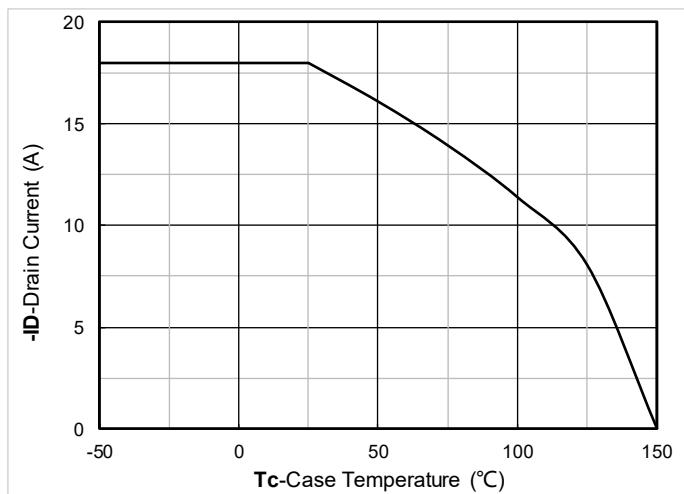


Figure11. Current dissipation

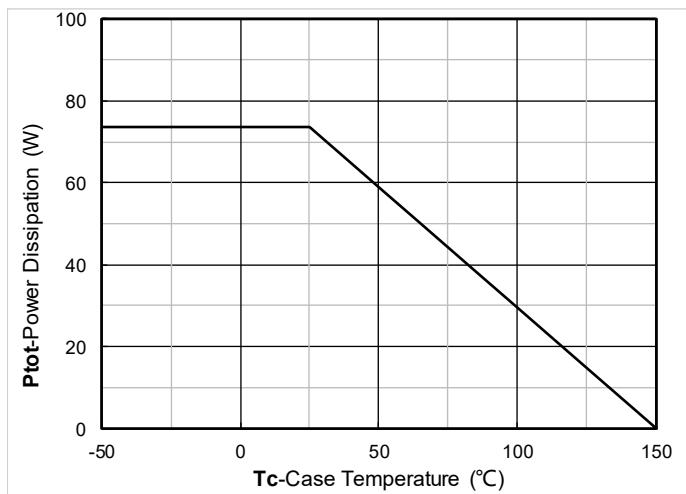


Figure12. Power dissipation

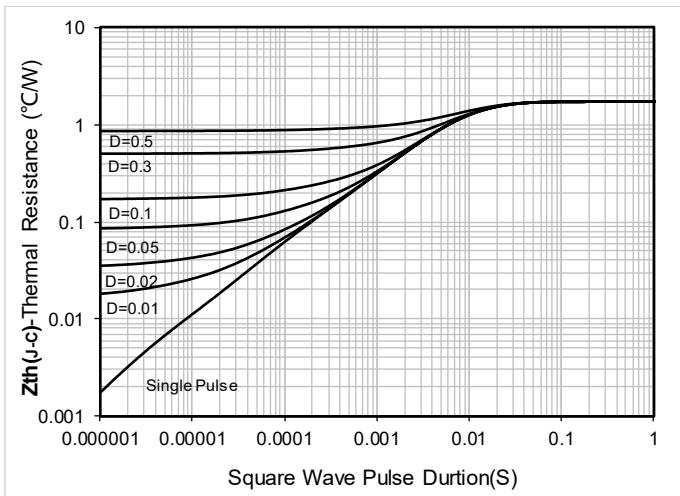


Figure13. Maximum Transient Thermal Impedance

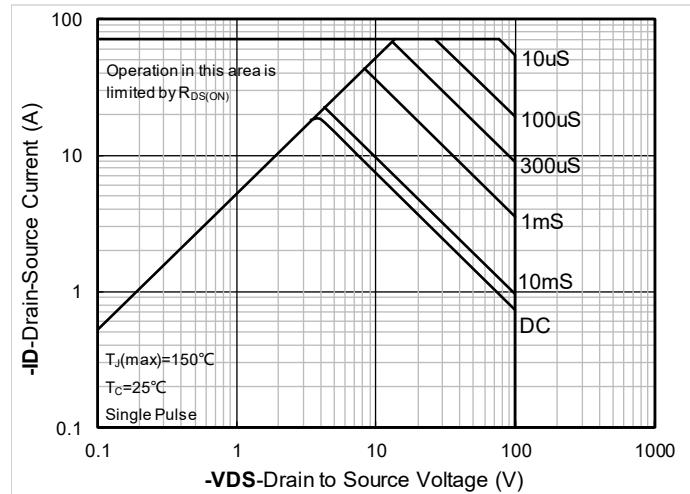
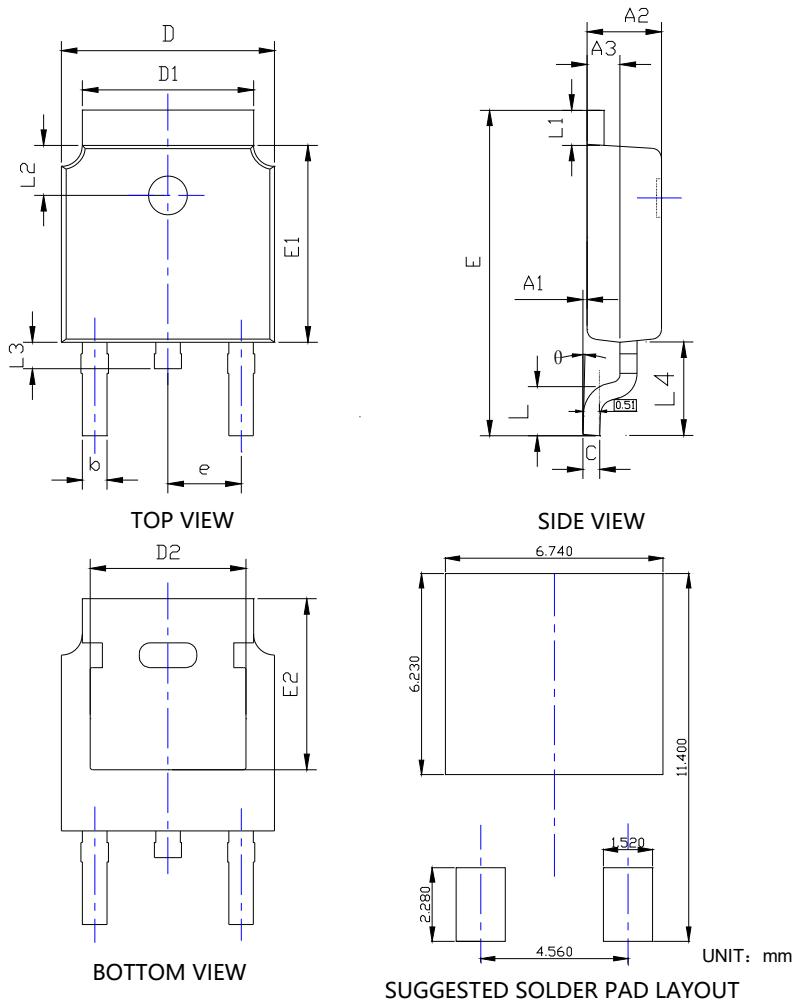


Figure14. Safe Operation Area

## ■ TO-252-B Package Information



| SYMBOL | INCHES   |       |       | Millimeter |        |        |
|--------|----------|-------|-------|------------|--------|--------|
|        | MIN.     | NOM.  | MAX.  | MIN.       | NOM.   | MAX.   |
| A1     | 0.000    | ---   | 0.008 | 0.000      | ---    | 0.200  |
| A2     | 0.087    | 0.091 | 0.094 | 2.200      | 2.300  | 2.400  |
| A3     | 0.035    | 0.039 | 0.043 | 0.900      | 1.000  | 1.100  |
| b      | 0.026    | 0.030 | 0.034 | 0.660      | 0.760  | 0.860  |
| c      | 0.018    | 0.020 | 0.023 | 0.460      | 0.520  | 0.580  |
| D      | 0.256    | 0.260 | 0.264 | 6.500      | 6.600  | 6.700  |
| D1     | 0.203    | 0.209 | 0.215 | 5.150      | 5.300  | 5.450  |
| D2     | 0.181    | 0.189 | 0.195 | 4.600      | 4.800  | 4.950  |
| E      | 0.390    | 0.398 | 0.406 | 9.900      | 10.100 | 10.300 |
| E1     | 0.236    | 0.240 | 0.244 | 6.000      | 6.100  | 6.200  |
| E2     | 0.203    | 0.209 | 0.215 | 5.150      | 5.300  | 5.450  |
| e      | 0.090BSC |       |       | 2.286BSC   |        |        |
| L      | 0.049    | 0.059 | 0.069 | 1.250      | 1.500  | 1.750  |
| L1     | 0.035    | ---   | 0.050 | 0.900      | ---    | 1.270  |
| L2     | 0.055    | ---   | 0.075 | 1.400      | ---    | 1.900  |
| L3     | 0.240    | 0.310 | 0.039 | 0.600      | 0.800  | 1.000  |
| L4     | 0.114REF |       |       | 2.900REF   |        |        |
| theta  | 0°       | ---   | 10°   | 0°         | ---    | 10°    |

## NOTE:

- 1.PACKAGE BODY SIZES EXCLUDE MOLD FLASH AND GATE BURRS.
- 2.TOLERANCE 0.1mm UNLESS OTHERWISE SPECIFIED.
- 3.THE PAD LAYOUT IS FOR REFERENCE PURPOSES ONLY.

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